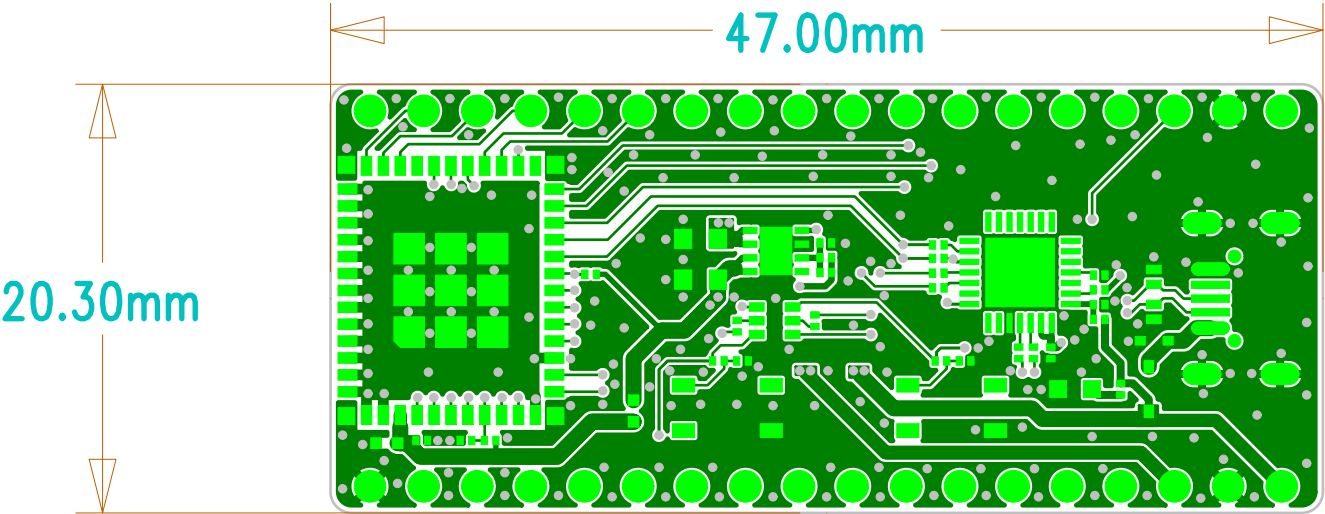
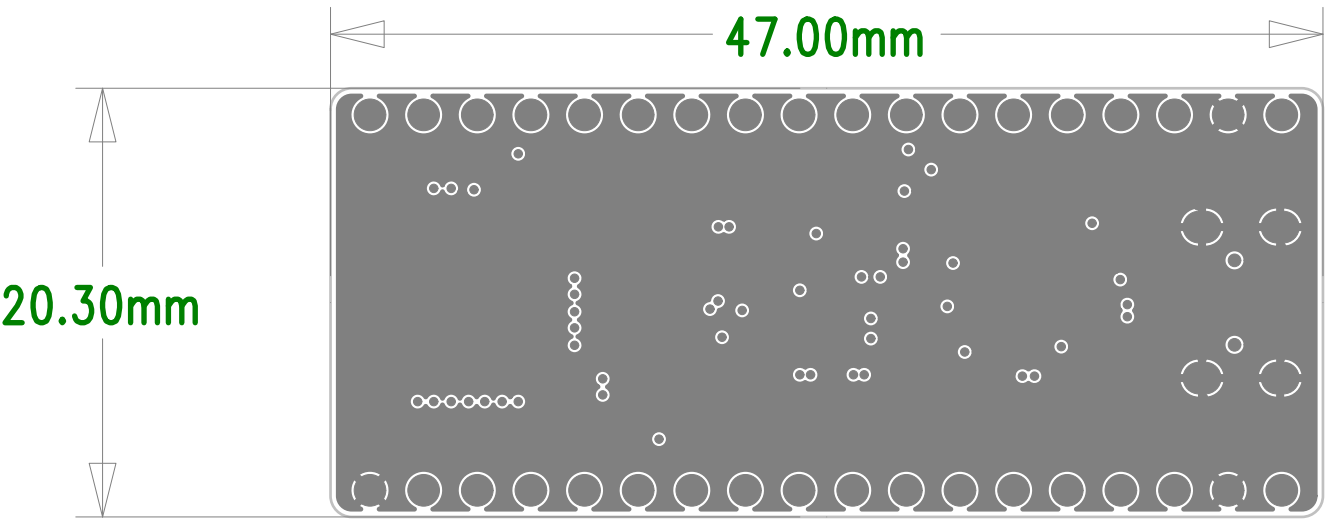
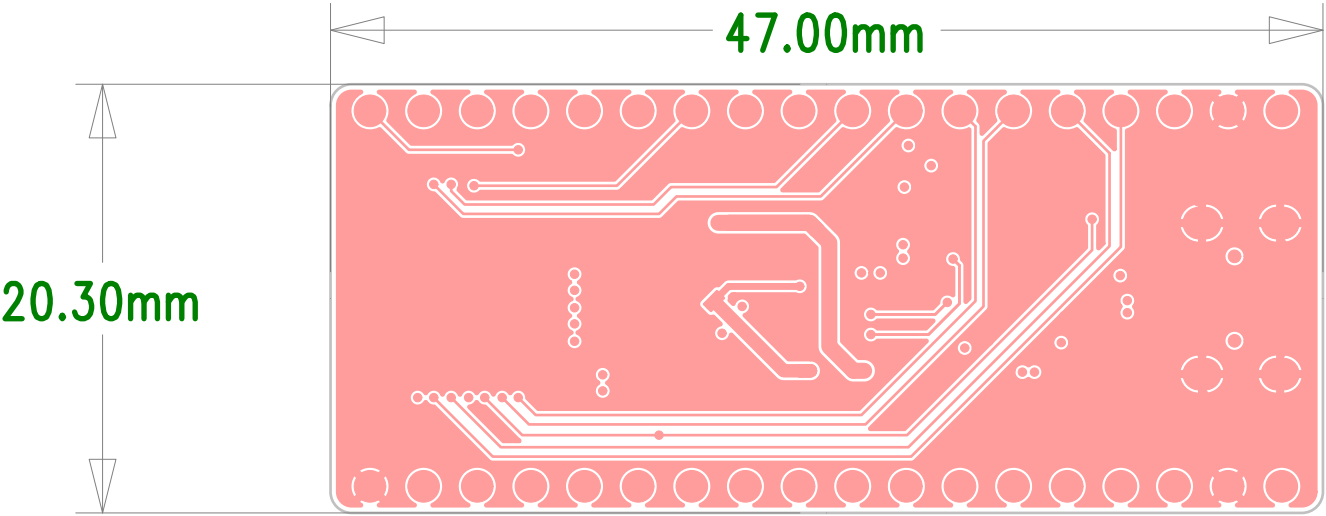
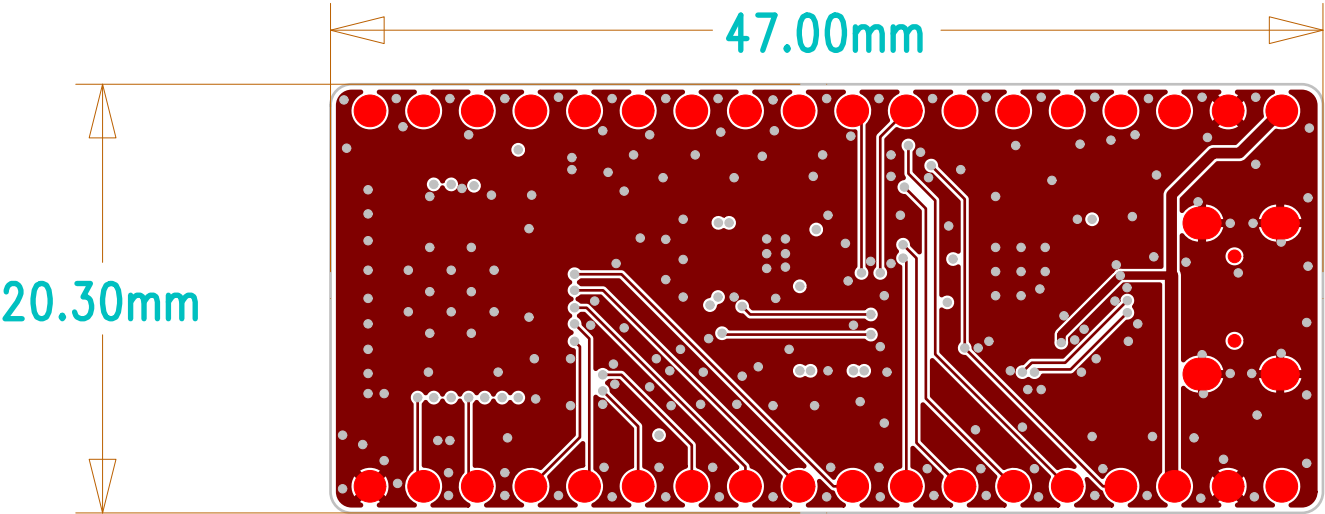
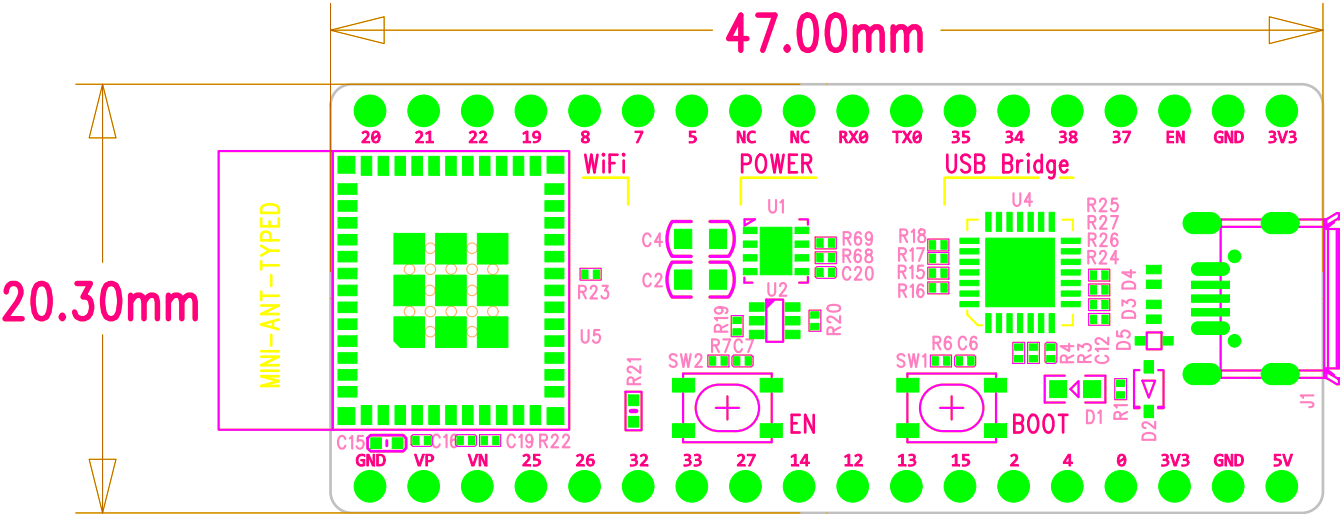


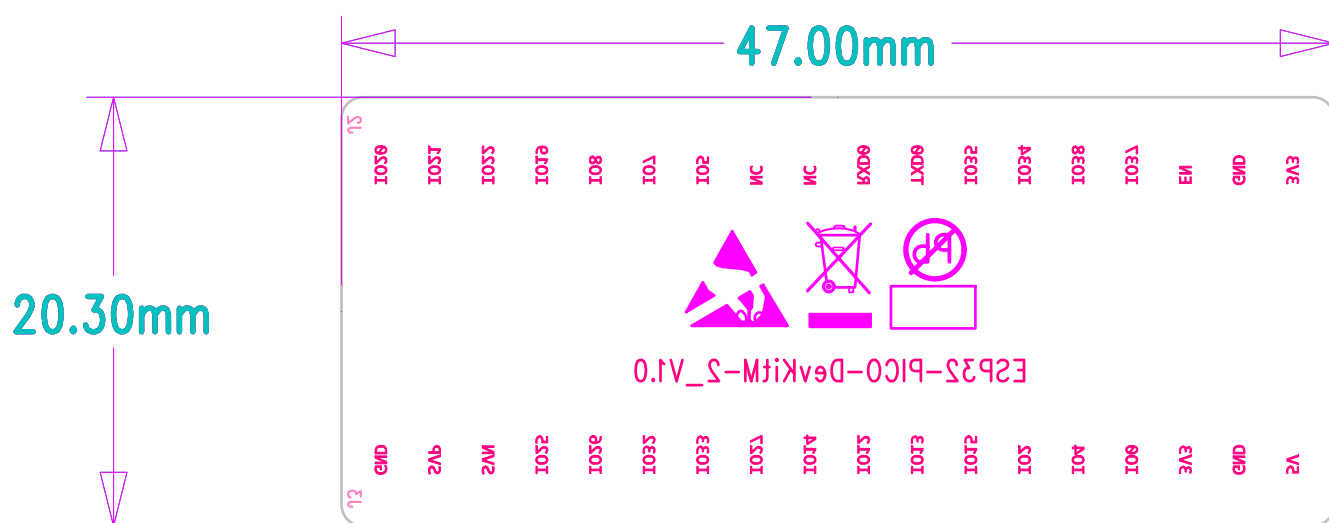


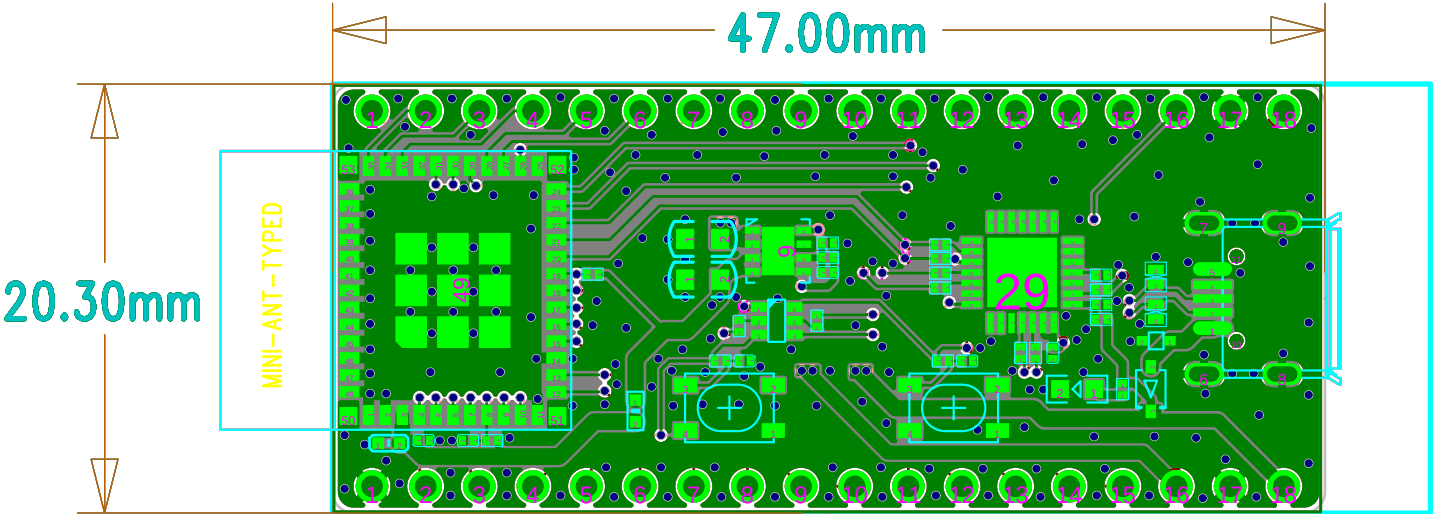












ESPRESSIF SYSTEM			
乐鑫科技 (上海) 股份有限公司			
Title	ESP32-PICO-DevKIM-2		
Task	#32825	Rev	1.0
Date	Wed, Aug 12, 2020	Confidential and Proprietary	

厚度 (mm)	阻抗 (Ohm)	电阻 (mΩ)	电感 (nH)	电容 (pF)
1.6	80	12.2	12.6	12.2

晶圆	封装	晶圆尺寸 (mm)	厚度 (mm)	介电常数
晶圆			0.4	4
L1_Top	成品晶圆 1 m	0.33	0.8	
L1_Pop	7828 TG180 RC80%		0	4.30
L2_Smd		1	1.2	
L2_Smd	SSR		可测	4.43
L3_Power		1	1.2	
L3_Pop	7828 TG180 RC80%		0	4.30
L4_Solder	成品晶圆 1 m	0.33	0.8	
晶圆			0.4	4